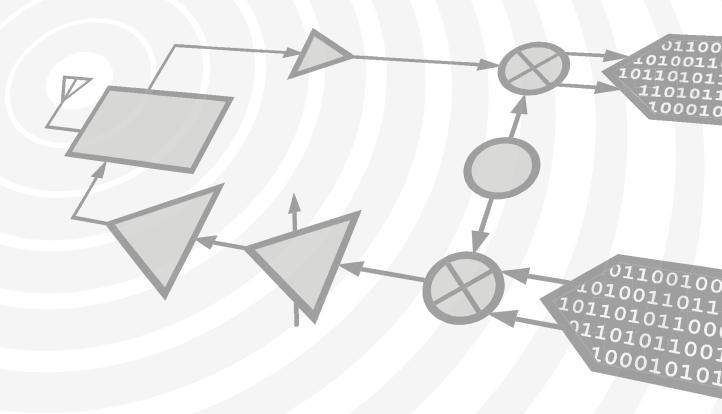




Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



www.hittite.com

www.analog.com

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MILITARY MANUFACTURING

Standard & Custom Products, DC to 110 GHz!

Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation

Facilities, Manufacturing & Test

- ♦ ISO 9001:2008 & AS9100:2009
- Class 100 Environment for S-Level Products
- Automatic Hybrid Assembly Equipment: Die Inspect/Pick, Die/Substrate Attach & Wire Bond
- ♦ IR Reflow Equipment for PCB Based Assemblies
- ♦ Automated Digital Product Test to 40 Gbps
- Automated RF, Microwave & Millimeterwave Product Test to 110 GHz





High Reliability Screening & Tests

- Wafer Lot Acceptance Test (WLAT) Bond Pull & Die Shear SEM Inspection Metal & Dielectric Thickness Meas.
- ♦ Temperature Cycle
- Constant Acceleration
- High Temp Burn-In
- Visual Inspection
- ♦ Vibration
- ♦ Fine & Gross Hermeticity
- ♦ Radiographic Inspection
- ♦ Particle Impact Noise Detection
- Residual Gas Analysis
- ESD Characterization
- Serialized Test Data
- Qualification Report

Hittite Delivers Qualified Solutions to Meet Your Specific Requirements!



CONTACT Us: mil@hittite.com

MILITARY PRODUCTS

Military Qualified Components, Modules & Subsystems!

Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation





Chip (Die)



Dielectric Resonator Oscillator



Hermetic Modules







Generator



Integrated Sub-Assembly



FPGA



Switched Filter Bank





Multi-Channel Downconverter



FET

FET Channel SEM

Hittite Provides Proven Technical Solutions for Military Applications!

- Vertical Integration with In-House MMIC & Module Design and Manufacturing
- Rapid Prototyping Capability Reduces Technical & Schedule Risks
- Custom IC Development Enables Advanced Performance with Miniature Size
- IC Manufacturing Infrastructure Provides Benefits in Controlling Performance, Quality, Schedule, Obsolescence, Packaging & Design Optimization
- Demonstrated Track Record of Industry Leadership and Key Supplier to the World's Most Trusted Defense System Integrators

World-Class IC, Module, and Subsystem Design and Manufacturing Solutions!



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Space Manufacturing

Space Qualified Processes, People & Facilities!

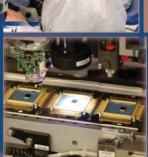
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Class S Screening & Qualification

- ♦ VI to Methods 2010A & 2017K
- ♦ Temperature Cycle
- ♦ High Temperature Burn-In & Life Test
- Wafer Lot Acceptance Test Bond Pull & Die Shear SEM Inspection Metal & Dielectric Thickness Meas.
- Serialized Test Data
- Qualification Report

Hittite Delivers Qualified Solutions to Meet Your Specific Requirements!



CONTACT Us: space@hittite.com

Space Products

Space Qualified Components, Modules & Subsystems!

Analog, Digital & Mixed-Signal ICs, Modules, Subsystems & Instrumentation



- Space Upscreening to Customer Specifications & Delivered over 45,000 S-Level Components
- Qualified By Major Spacecraft OEMs
- Space Level Products, Component & Module Qualification
- Offers MIL-PRF-38534-K & MIL-PRF-38535-S Class Screening on Die, Hermetic, Packaged Die & Hybrid Assemblies
- Space Grade Components Currently Operational on Dozens of Commercial, Scientific & Military Spacecraft

Your Source for State-of-the-Art Proven Performance!



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